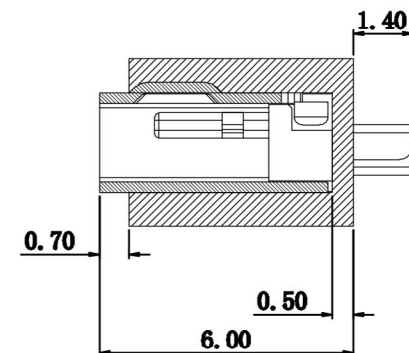
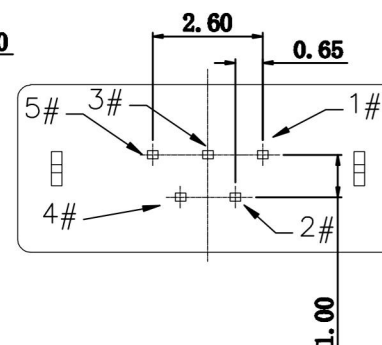
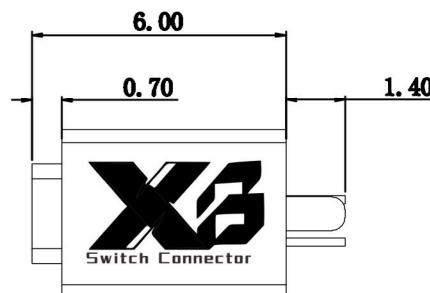
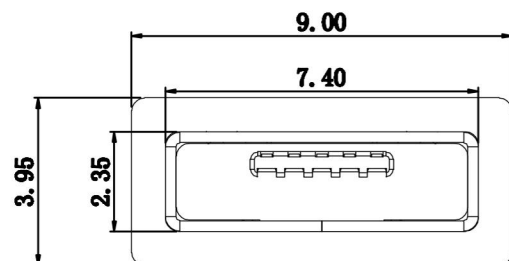
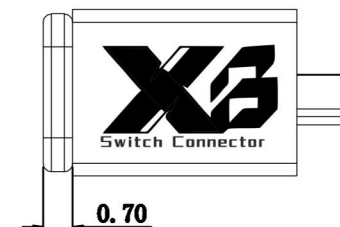
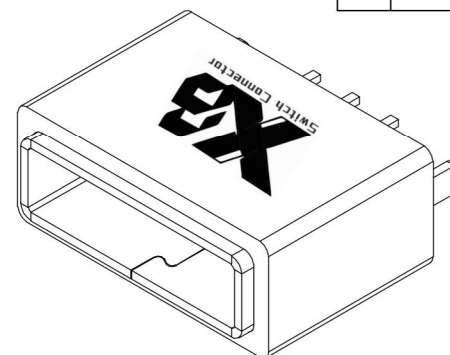
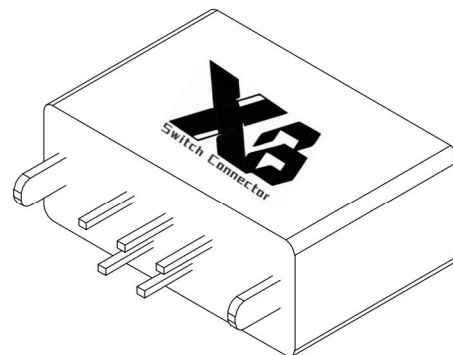
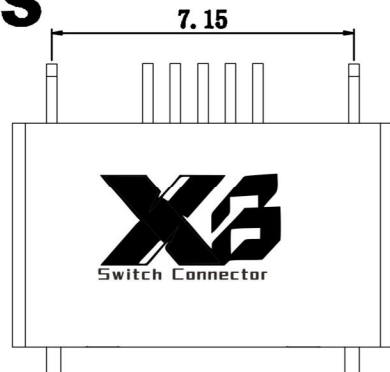


ROHS



Note:

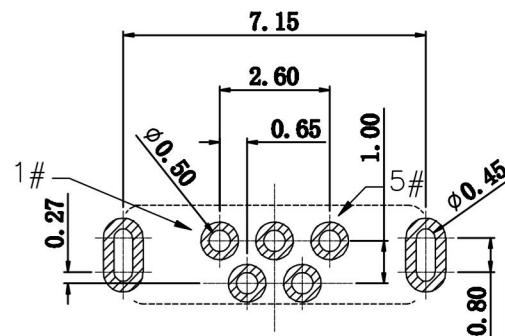
1. Material:

- 1.1 Housing: High temperature
thermoplastic with g.f, UL94v-0
1.2 Contact: copper alloy, t=0.20mm
1.3 Shell: sus 304, t=0.25mm

2. Specification:

- 2.1 Current rating: 1.8A Max
2.2 Dielectric withstanding voltage: 100V(AC)
for 1 min.
2.3 Contact resistance: 50mΩ Max.
2.4 Insulation resistance: 100mΩ min.
2.5 Total mating force: 3.57 Kgf Max.
2.6 Total unmating force: 1.0 Kgf
Min. 0.81~2.05 Kgf Min.

after 5,000 insertion/extraction cycles
2.7 Temperature range: $-30^{\circ}\text{C} \sim 80^{\circ}\text{C}$



Recommend PCB layout

REV	ECN DESCRIPTION	DATE	ECR
A	发行版	2015/11/16	赵 振

Contact Number	Signal Name	Remarks
1#	VBUS	Power
2#	D-	Date-
3#	D+	Date+
4#	ID	Reserve or Gound
5#	GND	Gound

GENERAL TOLERANCE		DWG NO		DRAWING	GAO PENG	SCALE	
X.±0.40	x.±	TITLE	MICRO USB-AB/F 180°	CHECKED	HE. LONG. FEI	UNIT	mm
.X±0.30	.x'±3'			APPROVAL	PANG. DONG		
.XX±0.20◀	.xx'±2'	PART NO	XB-USB-M-5P-1179-IPX7	DATE	2015/11/16		
.XXX±0.10	.xxx'±0.1'	SHEET	 东莞市溪榜电子有限公司 DONG GUAN XI BANG ELECTRONICS CO., LTD				
REV	A	SIZE		A4			